

13-BIT TO 26-BIT REGISTERED *IDT74SSTVN16859C* BUFFER WITH SSTL I/O

FEATURES:

- · 1:2 registered output buffer
- 2.3V to 2.7V operation for PC1600, PC2100, and PC2700
- 2.5V to 2.7V operation for PC3200
- SSTL_2 Class I style data inputs/outputs
- · Differential CLK input
- RESET control compatible with LVCMOS levels
- Latch-up performance exceeds 100mA
- ESD >2000V per MIL-STD-883, Method 3015; >200V using machine model (C = 200pF, R = 0)
- · Available in 56 pin VFQFPN and 64 pin TSSOP packages

APPLICATIONS:

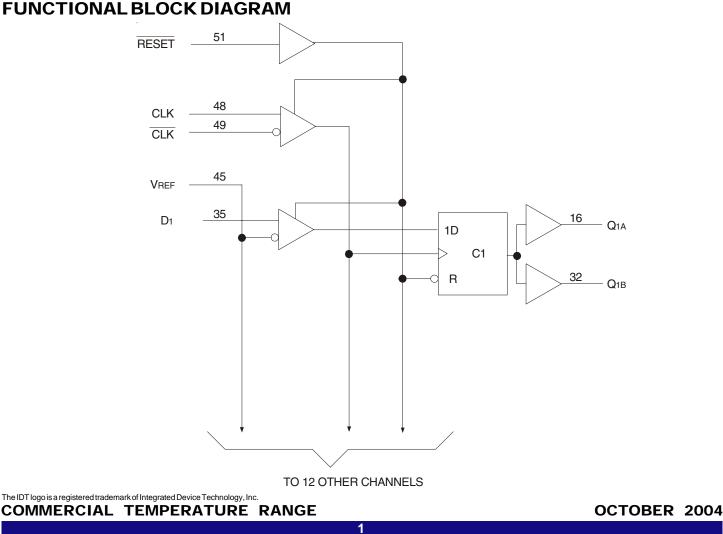
- Ideally suited for stacked DIMM DDR registered applications
- Along with CSPT857C/D, Zero Delay PLL Clock buffer, provides complete solution for DDR1 DIMMs

DESCRIPTION:

The SSTVN16859C is a 13-bit to 26-bit registered buffer designed for 2.3V-2.7V VDD for PC1600 - PC2700 and 2.5V-2.7V VDD for PC3200, and supports low standby operation. All data inputs and outputs are SSTL_2 level compatible with JEDEC standard for SSTL_2.

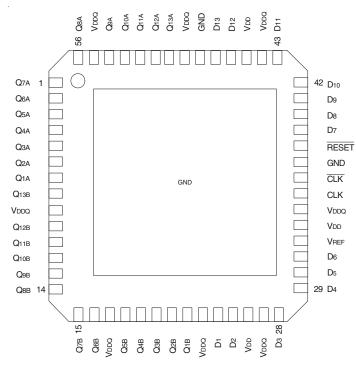
RESET is an LVCMOS input since it must operate predictably during the power-up phase. RESET, which can be operated independent of CLK and CLK, must be held in the low state during power-up in order to ensure predictable outputs (low state) before a stable clock has been applied.

RESET, when in the low state, will disable all input receivers, reset all registers, and force all outputs to a low state, before a stable clock has been applied. With inputs held low and a stable clock applied, outputs will remain low during the Low-to-High transition of **RESET**.



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PINCONFIGURATIONS



VFQFPN TOP VIEW

ABSOLUTE MAXIMUM RATINGS (1)

Symbol	Description	Max.	Unit
Vdd or Vddq	Supply Voltage Range	-0.5 to 3.6	V
VI ⁽²⁾	Input Voltage Range	-0.5 to VDD +0.5	V
V0 ⁽³⁾	Output Voltage Range	-0.5 to VDDQ +0.5	V
Ік	Input Clamp Current, Vi < 0	-50	mA
Іок	Output Clamp Current,	±50	mA
	VO < 0 or VO > VDDQ		
lo	Continuous Output Current,	±50	mA
	Vo = 0 to VDDQ		
Vdd	Continuous Current through each	±100	mA
	VDD, VDDQ or GND		
Tstg	Storage Temperature Range	-65 to +150	°C

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. The input and output negative voltage ratings may be exceeded if the ratings of the $\ensuremath{\text{I/P}}$ and $\ensuremath{\text{O/P}}$ clamp current are observed.

3. The output current will flow if the following conditions are observed:

a) Output in HIGH state

b) Vo = VDDQ

			۰ <i>۲</i>		1			
Q13A		1	\bigcirc	64		VDDQ		
Q 12A		2		63		GND		
Q 11A		3		62		D13		
Q 10A		4		61		D12		
Q9A		5		60		VDD		
Vddq		6		59		VDDQ		
GND		7		58		GND		
Q8A		8		57		D11		
Q7A		9		56		D10		
Q6A		10		55		D9		
Q5A		11		54		GND		
Q4A		12		53		D8		
Q3A		13		52		D7		
Q2A		14		51		RESET		
GND		15		50		GND		
Q1A		16		49		CLK		
Q13B		17		48		CLK		
Vddq		18		47		VDDQ		
Q 12B		19		46		VDD		
Q 11B		20		45		VREF		
Q10B		21		44		D6		
Q9B		22		43		GND		
Q8B		23		42		D5		
Q7B		24		41		D4		
Q6B		25		40		D3		
GND		26		39		GND		
Vddq		27		38		VDDQ		
Q5B		28		37		VDD		
Q4B		29		36		D2		
Q3B		30		35		D1		
Q2B		31		34		GND		
Q1B		32		33		VDDQ		
	TSSOP							

TOP VIEW

FUNCTION TABLE (1)

	Input					
RESET	CLK	CLK	D	Q Outputs		
Н	\uparrow	\rightarrow	L	L		
Н	\uparrow	\rightarrow	Н	Н		
Н	L or H	L or H	Х	Q0 ⁽²⁾		
L	Х	Х	Х	L		

NOTES:

1. H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

 \uparrow = LOW to HIGH

 \downarrow = HIGH to LOW

2. Qo = Output level before the indicated steady-state conditions were established.

PIN DESCRIPTION

Pin Names	Description
Q1 - Q13	Data Output
GND	Ground
VDDQ	Output-stage drain power voltage
Vdd	Logic power voltage
RESET	Asynchronous reset input - resets registers and disables data and clock differential input recievers
Vref	Input reference voltage
CLK	Positive master clock input
CLK	Negative master clock input
D1 - D13	Data Input - clocked in on the crossing of the rising edge of CLK and the falling edge of \overline{CLK}
Center PAD	Ground (MLF package only)

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR PC1600 - PC2700

Following Conditions Apply Unless Otherwise Specified: Operating Condition: TA = 0° C to +70°C, VDD = 2.5V ±0.2V, VDDQ = 2.5V ±0.2V

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vik	Control Inputs	VDD = 2.3V, II= -18mA	-	_	-1.2	V
Vон		$V_{DD} = 2.3V$ to 2.7V, IOH = -100 μ A		_	_	V
		VDD = 2.3V, IOH = -8mA	1.95	_	_	
Vol		VDD = 2.3V to 2.7V, IOL = 100µA	_	_	0.2	V
		VDD = 2.3V, IOL = 8mA	_	_	0.35	
lı	All Inputs	VDD = 2.7V,VI = VDD or GND	_	_	±5	μA
IDD	Static Standby	$IO = 0, VDD = 2.7V, \overline{RESET} = GND$	_	_	0.01	mA
	Static Operating	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC)	-	_	20	
	Dynamic Operating (Clock Only)	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	_	6	_	µA/Clock
		CLK and CLK Switching 50% Duty Cycle.				MHz
IDDD	Dynamic Operating	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	_	43	_	µA/Clock
	(Per Each Data Input) ⁽¹⁾	CLK and CLK Switching 50% Duty Cycle. One Data Input				MHz/Data
		Switching at Half Clock Frequency, 50% Duty Cycle.				Input
	Data Inputs	Vdd = 2.5V, Vi = Vref ± 310mV	2.5	_	3.5	
Сі	CLK and CLK	VICR = 1.25V, VI (PP) = 360mV	2.5	_	3.5	рF
	RESET	VI = VDD or GND	2	_	3	

NOTE:

1. Power dissipation levels will allow operation at DDR333 speeds without excessive die temperature.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR PC3200

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA = 0° C to +70°C, VDD = 2.6V ±0.1V, VDDQ = 2.6V ±0.1V

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vik	Control Inputs	Vdd = 2.5V, II= -18mA	-	_	-1.2	V
Vон	VDD = 2.5V to 2.7V, IOH = -100µA		Vdd - 0.2			V
		Vdd = 2.5V, Ioh = -8mA	1.95	_	—	
Vol		VDD = 2.5V to 2.7V, IOL = 100µA	_		0.2	V
		Vdd = 2.5V, Iol = 8mA	_	_	0.35	
lı	All Inputs	VDD = 2.7V,VI = VDD or GND	_	_	±5	μA
Idd	Static Standby	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = GND	_	-	0.01	mA
	Static Operating	IO = 0, VDD = 2.7V, RESET = VDD, VI = VIH (AC) or VIL (AC)	-	-	20	
	Dynamic Operating (Clock Only)	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	_	6	_	µA/Clock
		CLK and CLK Switching 50% Duty Cycle.				MHz
IDDD	Dynamic Operating	IO = 0, VDD = $2.7V$, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	_	43	_	µA/Clock
	(Per Each Data Input) ⁽¹⁾	CLK and CLK Switching 50% Duty Cycle. One Data Input				MHz/Data
		Switching at Half Clock Frequency, 50% Duty Cycle.				Input
	Data Inputs	Vdd = 2.6V, VI = Vref ± 310mV	2.5	_	3.5	
Сі	CLK and CLK	VICR = 1.3V, VI (PP) = 360mV	2.5	_	3.5	pF
	RESET	VI = VDD or GND	2	_	3	

NOTE:

1. Power dissipation levels will allow operation at DDR400 speeds without excessive die temperature.

OPERATING CHARACTERISTICS, TA = 25°C (1)

Symbol	Parameter		Min.	Тур. ⁽¹⁾	Max.	Unit
Vdd	Supply Voltage		VDDQ	_	2.7	V
VDDQ	Output Supply Voltage	PC1600 - PC12700	2.3	2.5	2.7	V
		PC3200	2.5	2.6	2.7	
Vref	Reference Voltage (VREF=VDDQ/2)	PC1600 - PC2700	1.15	1.25	1.35	V
		PC3200	1.25	1.3	1.35	
Vtt	Termination Voltage		VREF-40mV	Vref	VREF+ 40mV	V
Vi	Input Voltage		0	—	Vdd	V
Vih	AC High-Level Input Voltage	Data Inputs	VREF+ 310mV	—	-	V
VIL	AC Low-Level Input Voltage	Data Inputs	—	—	Vref-310mV	V
Vih	DC High-Level Input Voltage	Data Inputs	VREF+ 150mV	—	—	V
VIL	DC Low-Level Input Voltage	Data Inputs	_	_	Vref-150mV	V
Vih	High-Level Input Voltage	RESET	1.7	_	_	V
Vil	Low-Level Input Voltage	RESET	—	_	0.7	V
VICR	Common-Mode Input Range	CLK, CLK	0.97	_	1.53	V
VI (PP)	Peak-to-Peak Input Voltage	CLK, CLK	360	—	—	mV
Іон	High-Level Output Current			_	- 16	mA
Iol	Low-Level Output Current		_	_	16	
TA	Operating Free-Air Temperature		0	_	+70	°C

NOTE:

1. The RESET input of the device must be held at Vod or GND to ensure proper device operation.

TIMING REQUIREMENTS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE

			PC1600-PC2700		PC3200		
Symbol	Parameter		Min.	Max.	Min.	Max.	Unit
CLOCK	Clock Frequency		_	200	_	220	MHz
tw	Pulse Duration, CLK, CLK HIGH or LOW		2.5	—	2.5	—	ns
t ACT	Differential Inputs Active Time ⁽¹⁾			22		22	ns
t INACT	Differential Inputs Inactive Time ⁽²⁾		_	22	—	22	ns
tsu	Setup Time, Fast Slew Rate ^(3,5)	Data Before CLK↑, CLK↓	0.65	—	0.65	—	ns
	Setup Time, Slow Slew Rate ^(4, 5)		0.75	—	0.75	—	ns
ħ	Hold Time, Fast Slew Rate ^(3,5)	Data Before CLK \uparrow , CLK \downarrow	0.75	—	0.65	—	ns
	Hold Time, Slow Slew Rate ^(2,5)		0.9	_	0.8	_	ns

NOTES:

1. Data inputs must be low a minimum time of tACT max., after RESET is taken HIGH.

2. Data and clock inputs must be held at valid levels (not floating) a minimum time of tINACT max., after RESET is taken LOW.

3. For data signal input slew rate is ≥ 1 V/ns.

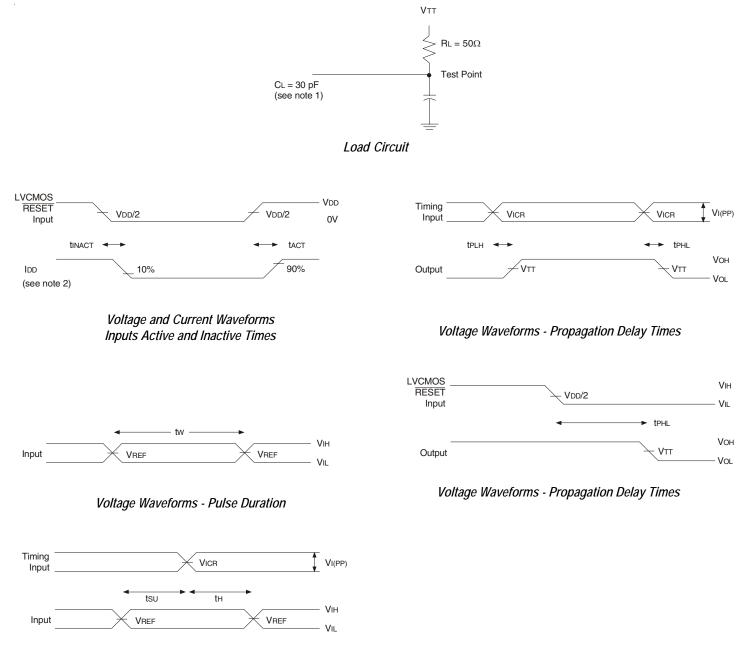
4. For data signal input slew rate is ≥ 0.5 V/ns and <1V/ns.

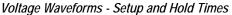
5. CLK, $\overline{\text{CLK}}$ signal input slew rates are ≥ 1 V/ns.

SWITCHING CHARACTERISTICS OVER RECOMMENDED FREE-AIR OPERATING RANGE (UNLESS OTHERWISE NOTED)

			PC1600-PC2700		0 PC3200		
Symbol	Parameter	Package	Min.	Max.	Min.	Max.	Unit
fmax		TSSOP, VFQFPN	200	_	220	—	MHz
t PDM	CLK and CLK to Q	TSSOP	1.1	2.4	1.1	2.2	ns
		VFQFPN	1	2.2	1	1.8	
t PDMSS	CLK and $\overline{\text{CLK}}$ to Q (simultaneous switching)	TSSOP	_	2.7		2.5	ns
		VFQFPN	—	2.5		2.1	
T PHL	RESET to Q	TSSOP, VFQFPN	_	5	_	5	ns

TEST CIRCUITS AND WAVEFORMS FOR PC1600 - PC2700, VDD = $2.5V \pm 0.2V$ FOR PC3200, VDD = $2.6V \pm 0.1V$

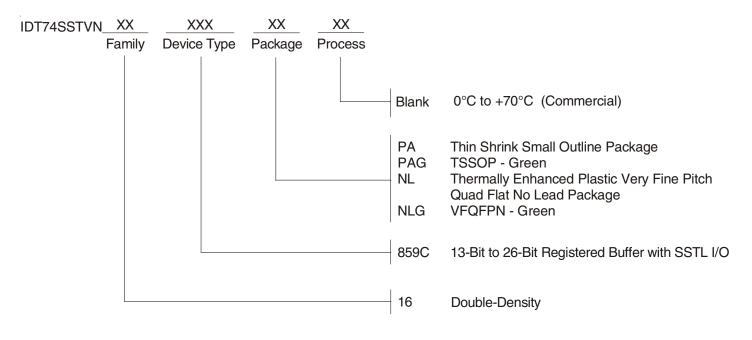




NOTES:

- 1. CL includes probe and jig capacitance.
- 2. IDD tested with clock and data inputs held at VDD or GND, and IO = 0mA.
- 3. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Zo = 50 Ω , input slew rate = 1 V/ns $\pm 20\%$ (unless otherwise specified).
- 4. The outputs are measured one at a time with one transition per measurement.
- 5. VTT = VREF = VDDQ/2
- 6. VIH = VREF + 310mV (AC voltage levels) for differential inputs. VIH = VDD for LVCMOS input.
- 7. VIL = VREF 310mV (AC voltage levels) for differential inputs. VIL = GND for LVCMOS input.
- 8. tPDM is tPD with one output switching. tPDMss is tPD with all outputs switching.

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